

# Declaration and Power of Attorney for Patent Application 特許出願宣告書

## Japanese Language Declaration

私は、下欄に氏名を記載した発明者として、以下のとおり宣告する。：

私の住所、郵便の宛先および国籍は、下欄に氏名に続いて記載したとおりであり、

名称の発明に関し、請求の範囲に記載した特許を求める主題の本来の、最初にして唯一発明者である（一人の氏名のみが下欄に記載されている場合）か、もしくは本来の最初にして共同の発明者である（複数の氏名が下欄に記載されている場合）と信じ、

その明細書を

（該当する方に印を付す）

☐ ここに添付する。

☐ \_\_\_\_\_ 日に出願番号

第 \_\_\_\_\_ 号として提出し、

\_\_\_\_\_ 日に補正した。

（該当する場合）

私は、前記のとおり補正した請求の範囲を含む前記明細書の内容を検討し、理解したことを陳述する。

私は、連邦規則法典第 37 部第 1 章第 56 条(a)項に従い、本願の審査に所要の情報を開示すべき義務を有することを認める。

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first, and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled.

SEMICONDUCTOR WAFER, SEMICONDUCTOR CHIP

AND DICING METHOD OF A SEMICONDUCTOR WAFER

the specification of which  
(check one)

☒ is attached hereto.

☐ was filed on \_\_\_\_\_ as

Application Serial No. \_\_\_\_\_

and was amended on \_\_\_\_\_  
(if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with the Title 37, Code of Federal Regulations, § 1.56(a).

## Japanese Language Declaration

私は、合衆国法典第 35 部第 119 条にもとづく下記の外国特許出願または発明者証出願の外国優先権を主張し、さらに優先権の主張に係わる基礎出願の出願日前の出願日を有する外国特許出願または発明者証出願を以下に明記する：

### Prior Foreign Application(s)

先の外国出願

P 2002-302993

Japan

17/10/2002

(Number)  
(番号)

(Country)  
(国名)

(Day/Month/Year Filed)  
(出願の年月日)

### Priority Claimed

優先権の主張

☒ Yes ☐ No  
あり なし

(Number)  
(番号)

(Country)  
(国名)

(Day/Month/Year Filed)  
(出願の年月日)

☐ Yes ☐ No  
あり なし

(Number)  
(番号)

(Country)  
(国名)

(Day/Month/Year Filed)  
(出願の年月日)

☐ Yes ☐ No  
あり なし

私は、合衆国法典第 35 部第 120 条にもとづく下記の合衆国特許出願の利益を主張し、本願の請求の範囲各項に記載の主題が合衆国法典第 35 部 112 条第 1 項に規定の態様で先の合衆国出願に開示されていない限度において、先の出願の出願日と本願の国内出願日または PCT 国際出願日の間に公表された連邦規則法典第 37 部第 1 章第 56 条(a)項に記載の所要の情報を開示すべき義務を有することを認める：

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56 (a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)  
(出願番号)

(Filing Date)  
(出願日)

(Status: patented, pending, abandoned)  
(現況: 特許済、係属中、放棄済)

(Application Serial No.)  
(出願番号)

(Filing Date)  
(出願日)

(Status: patented, pending, abandoned)  
(現況: 特許済、係属中、放棄済)

私は、ここに自己の知識にもとづいて行った陳述がすべて真実であり、自己の有する情報および信ずるところに従って行った陳述が真実であると信じ、さらに故意に虚偽の陳述等を行った場合、合衆国法典第 18 部第 1001 条により、罰金もしくは禁錮に処せられるか、またはこれらの刑が併科され、またかかる故意による虚偽の陳述が本題ないし本願に対して付与される特許の有効性を損うことがあることを認識して、以上の陳述を行ったことを宣言する。

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

# Japanese Language Declaration

委任状：私は、下記発明者として、以下の代理人  
ここに選任し、本願の手續を遂行すること並びに  
これに関する一切の行為を特許商標庁に対して行  
うことを委任する。(代理人氏名および登録番号を  
明記のこと)

Stanislaus Aksman, Reg. No. 28,562; Edward A. Becker, Reg. No. 37,777; Stephen A. Becker, Reg. No. 26,527;  
William H. Beha, Reg. No. 38,038; John G. Bisbikis, Reg. No. 37,095; Kenneth L. Cage, Reg. No. 26,151; Stephen  
C. Carlson, Reg. No. 39,929; Paul Devinsky, Reg. No. 28,553; Laura A. Dornelly, Reg. No. 38,435; Margaret M.  
Duncan, Reg. No. 30,879; Brian E. Ferguson, Reg. No. 36,801; Michael F. Fogarty, Reg. No. 36,139; Wilhelm F.  
Gadiano, Reg. No. 37,136; Keith E. George, Reg. No. 34,111; John A. Hankins, Reg. No. 32,029; Thomas A. Jolly,  
Reg. No. 39,241; Eric J. Kraus, Reg. No. 36,190; Edward E. Kubasiewicz, Reg. No. 30,020; Robert E. LeBlanc, Reg.  
No. 17,219; Jack Q. Lever, Reg. No. 28,149; Raphael V. Lupo, Reg. No. 28,363; Christine F. Martin, Reg. No.  
39,762; Michael E. McCabe, Jr., Reg. No. 37,182; James H. Meadows, Reg. No. 33,965; Michael A. Messina, Reg.  
No. 33,424; Joseph H. Paquin, Jr., Reg. No. 31,647; Craig L. Plastrik, Reg. No. 41,254; Robert L. Price, Reg.  
No. 22,685; Paul A. Roberts, Reg. No. 40,289; Gene Z. Robinson, Reg. No. 33,351; Joy Ann G. Serauskas, Reg.  
No. 27,952; Michele M. Schafer, Reg. No. 34,717; David J. Serbin, Reg. No. 30,589; Glenn Snyder, Reg. No.  
41,428; Arthur J. Steiner, Reg. No. 26,106; David L. Stewart, Reg. No. 37,578; Leonid D. Thedor, Reg. No.  
39,397; Keith J. Townsend, Reg. No. 40,358; Leon R. Turkevich, Reg. No. 34,035; Christopher D. Ward, Reg. No.  
41,367; Damian G. Wasserbauer, Reg. No. 34,749; Edward J. Wise, Reg. No. 34,523; Alexander V. Yampolsky, Reg.  
No. 36,324; and Robert W. Zelnick, Reg. No. 36,976

POWER OF ATTORNEY: As a named inventor, I  
hereby appoint the following attorney(s) and/or  
agent(s) to prosecute this application and transact all  
business in the Patent and Trademark Office  
connected therewith. (list name and registration  
number)

書類の送付先:

Send Correspondence to:

McDERMOTT, WILL & EMERY  
600 13th Street, N.W.  
Washington, D.C. 20005-3096

直接電話連絡先: (名称及び電話番号)

Direct Telephone Calls to: (name and telephone number)

Stephen A. Becker  
(202) 756-8000

第一のまたは第一の発明者の氏名	Full Name of First Joint Inventor Ryu MAKABE	
同発明者の署名	First inventor's signature <i>Ryu Makabe</i>	Date August 1, 2003
住所	Residence Tokyo, Japan	
国籍	Citizenship Japan	
郵便の宛先	Post Office Address c/o Renesas Technology Corp., 4-1, Marunouchi 2-chome, Chiyoda-ku, Tokyo 100-6334 Japan	
第二の共同発明者の氏名 (該当する場合)	Full Name of Second Joint Inventor Yuichi KUNORI	
同第二発明者の署名	Second inventor's signature <i>Yuichi Kunori</i>	Date August 2, 2003
住所	Residence Tokyo, Japan	
国籍	Citizenship Japan	
郵便の宛先	Post Office Address c/o Renesas Technology Corp., 4-1, Marunouchi 2-chome, Chiyoda-ku, Tokyo 100-6334 Japan	

(第三またはそれ以降の共同発明者に対しても同様な情  
報および署名を提供すること。)

(Supply similar information and signature for third and  
subsequent joint inventors.)

Docket No.: 67162-021

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of	:	Customer Number: 20277
	:	
Ryu MAKABE, et al.	:	Confirmation Number:
	:	
Serial No.:	:	Group Art Unit:
	:	
Filed: September 16, 2003	:	Examiner: Unknown
	:	
For:		SEMICONDUCTOR WAFER, SEMICONDUCTOR CHIP AND DICING METHOD OF A SEMICONDUCTOR WAFER

**ASSOCIATE POWER OF ATTORNEY**

Mail Stop  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

The undersigned Principal Attorney of record hereby appoints the following Attorneys as his Associates with regard to the above-identified application: Steven W. Allis, Reg. No. 50,532; Stephen A. Becker, Reg. No. 26,527; John G. Bisbikis, Reg. No. 37,095; Daniel Bucca, Reg. No. 42,368; Kenneth L. Cage, Reg. No. 26,151; Jennifer Chen, Reg. No. 42,404; Bernard P. Codd, Reg. No. 46,429; Lawrence T. Cullen, Reg. No. 44,489; Paul Devinsky, Reg. No. 28,553; Margaret M. Duncan, Reg. No. 30,879; Shamita De. Etienne-Cummings, Reg. No. 46,072; Ramyar M. Farid, Reg. No. 46,692; Brian E. Ferguson, Reg. No. 36,801; Michael E. Fogarty, Reg. No. 36,139; John R. Fuisz, Reg. No. 37,327; Keith E. George, Reg. No. 34,111; John A. Hankins, Reg. No. 32,029; Eric J. Kraus, Reg. No. 36,190; Catherine Krupka, Reg. No. 46,227; Jack Q. Lever, Reg. No. 28,149; Raphael V. Lupo, Reg. No. 28,363; Burman Y. Mathis III, Reg. No. 44,907; Michael A. Messina, Reg. No. 33,424; Dawn L. Palmer, Reg. No. 41,238; Joseph H. Paquin, Jr., Reg. No. 31,647; Scott D. Paul, Reg. No. 42,984; William D. Pegg, Reg. No. 42,988; Robert L. Price, Reg. No. 22,685; Gene Z. Robinson, Reg. No. 33,351; Brian K. Seidleck, Reg. No. 51,321; Joy Ann G. Serauskas, Reg. No. 27,952; Jiri F. Smetana, Reg. No. 52,456; David A. Spenard, Reg. No. 37,449; Arthur J. Steiner, Reg. No. 26,106; Michael D. Switzer, Reg. No. 39,552; David M. Tennant, Reg. No. 48,362; Judith L. Toffenetti, Reg. No. 39,048; Daniel S. Trainor, Reg. No. 43,959; Shival P. Virmani, Reg. No. 45,032; Kelli N. Watson, Reg. No. 47,170;

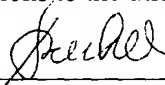
**Serial No.:**

Cameron K. Weiffenbach, Reg. No. 44,488; Aaron Weisstuch, Reg. No. 41,557; Edward J. Wise, Reg. No. 34,523; Jeffrey A. Woller, Reg. No. 48,041; Alexander V. Yampolsky, Reg. No. 36,324; Robert W. Zelnick, Reg. No. 36,976; and Wei-Chen Chen, admitted under 37 CFR 10.9(b) all of

McDERMOTT, WILL & EMERY  
600 13th Street, N.W.  
Washington, DC 20005-3096

Please continue to address all communications to the undersigned.

September 16, 2003

By   
\_\_\_\_\_  
Stephen A. Becker  
Registration No. 26,527  
Attorney for Applicant